Maximum Ratings

Parameter	Symbol	Value	Unit
Collector-Emitter Breakdown Voltage	V_{CE}	1350	V
DC collector current, limited by T_{jmax} T_C = 25°C T_C = 100°C	I_C	 50 25	A
Diode Forward current, limited by T_{jmax} T_C = 25°C T_C = 100°C	I_F	 50 25	A
Continuous Gate-emitter voltage	V_{GE}	±20	V
Transient Gate-emitter voltage	V_{GE}	±30	V
Turn off safe operating area V_{CE} ≤1350V, T_j ≤ 150°C	-	75	A
Pulsed collector current, V_{GE}= 15V, t_p limited by T_{jmax}	I_{CM}	75	A
Power dissipation , Tj=25℃	Ptot	260	W
Operating junction temperature	T_j	-40...+150	℃
Storage temperature	T_s	-55...+150	

Electrical Characteristics of the IGBT（T_j= 25℃ unless otherwise specified）：

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Static						
Collector-Emitter breakdown voltage	BV_{CES}	V_{GE}=0V , I_C=1mA	1350	1450	-	V
		V_{GE}=0V , I_C=10mA	1350	1450	-	V
Gate threshold voltage	$V_{GE(th)}$	V_{GE}=V_{CE}, I_C=250μA	5.1	5.8	6.4	V
Collector-Emitter Saturation voltage	$V_{CE(sat)}$	V_{GE}=15V, I_C=25A T_j = 25°C T_j = 150°C	 - -	 2.0 2.5	 2.5 -	V
Zero gate voltage collector current	I_{CES}	V_{CE} = 1350V, V_{GE} = 0V T_j = 25°C T_j = 150°C	 - -	 <1 -	 100 1000	μA
Gate-emitter leakage current	I_{GES}	V_{CE} = 0V, V_{GE} = ±20V	-	-	100	nA
Transconductance	g_{fs}	V_{CE}=20V, I_C=25A	-	13	-	S

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Dynamic						
Input capacitance	C_{ies}	V_{CE} = 25V, V_{GE} = 0V, f = 1MHz	-	2500	-	pF
Output capacitance	C_{oes}		-	70	-	
Reverse transfer capacitance	C_{res}		-	50	-	
Gate charge	Q_G	V_{CC} = 640V, I_C = 25A, V_{GE} = 15V	-	135	-	nC

Switching Characteristic, Inductive Load

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Dynamic , at T_j = 25° C						
Turn-off delay time	$td_{(off)}$	V_{CC} = 600V, I_C = 25A, V_{GE} = 0/15V, R_g=12Ω	-	155	-	ns
Fall time	t_f		-	35	-	ns
Turn-off energy	E_{off}		-	0.65	-	mJ
Dynamic , at T_j = 150° C						
Turn-off delay time	$td_{(off)}$	V_{CC} = 600V, I_C = 25A, V_{GE} = 0/15V, R_g=12Ω	-	170	-	ns
Fall time	t_f		-	60	-	ns
Turn-off energy	E_{off}		-	1.4	-	mJ

Electrical Characteristics of the DIODE（T_j= 25℃ unless otherwise specified）

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Dynamic						
Diode Forward Voltage	V_{FM}	I_F = 25A	-	2.3	-	V
Reverse Recovery Time	T_{rr}	I_F= 25A, di/dt= 200A/μs	-	460	-	ns
Reverse Recovery Current	I_{rr}		-	17	-	A
Reverse Recovery Charge	Q_{rr}		-	3600	-	nC

Fig. 1 FE

Fig. 2 Load Current vs. Frequency

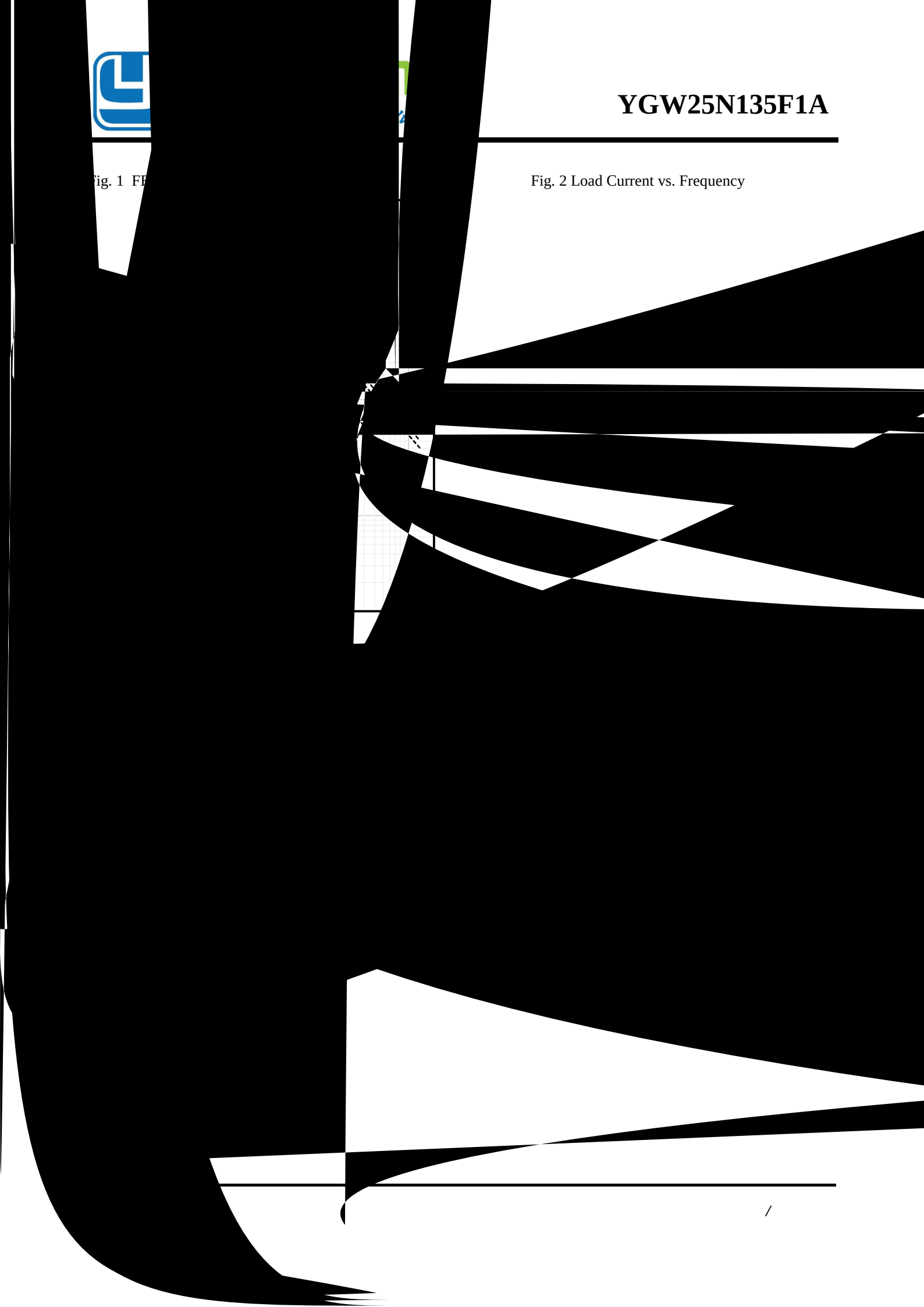

Fig. 5 Typical Saturation Voltage vs.Junction emperature

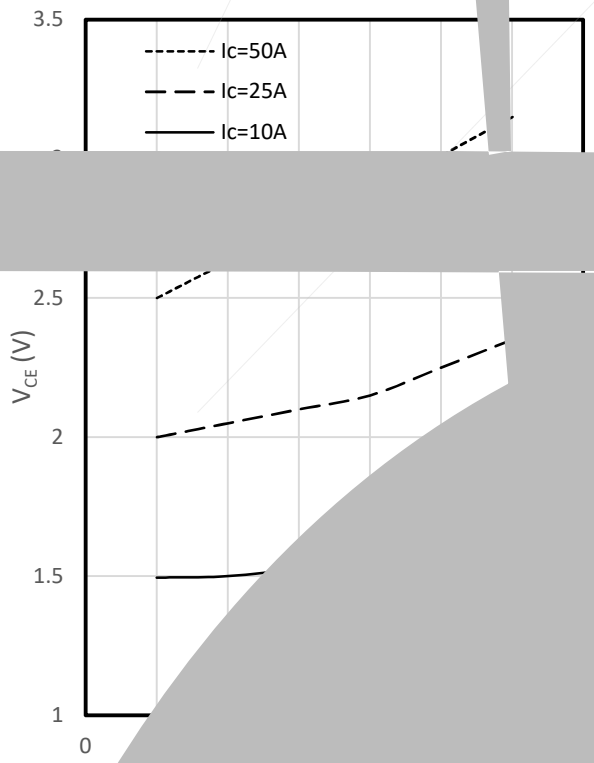

Fig. 6 Typical Diode Forward Characteristics

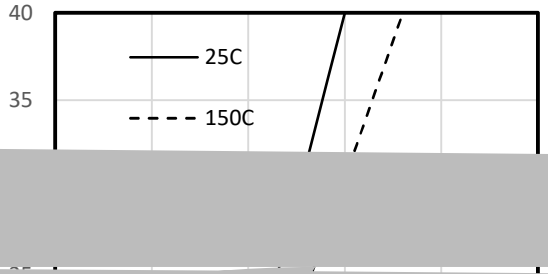

Fig. 7 T

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Fig. 13 Capacitance characteristics

Fig. 14 Gate charge characteristics

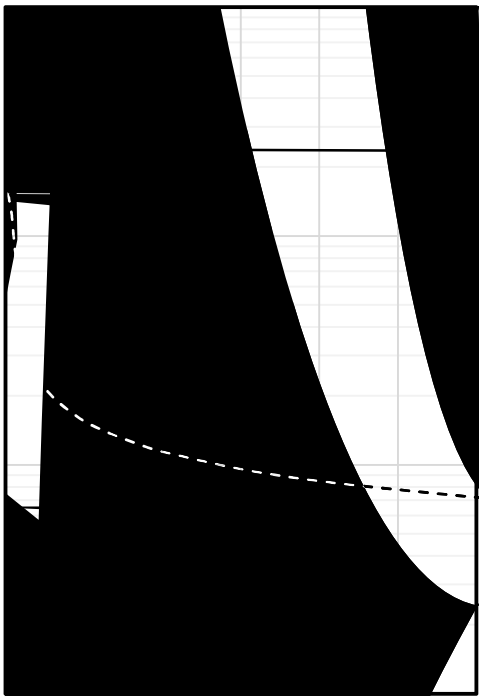

Fig. 15 IGBT Transient Thermal Impedance

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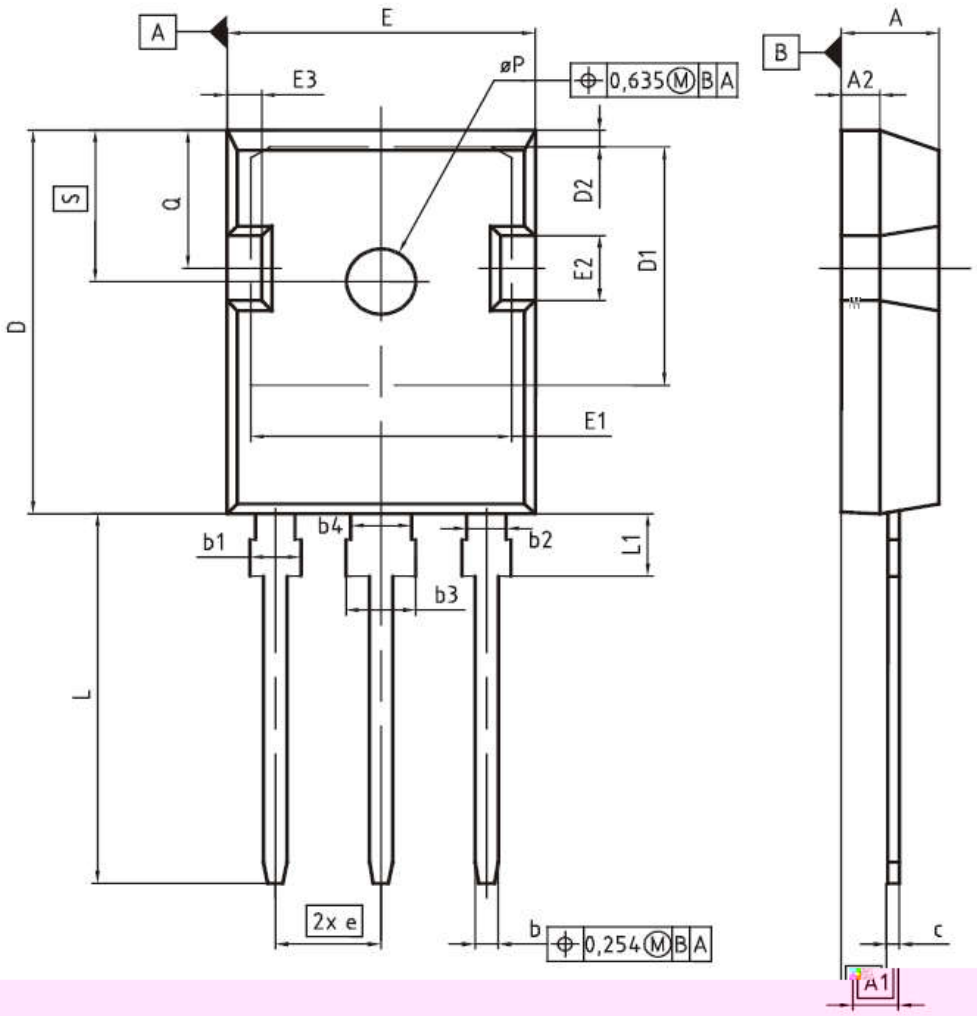

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.83	5.21	0.190	0.205
A1	2.27	2.54	0.089	0.100
A2	1.85	2.16	0.073	0.085
b	1.07	1.33	0.042	0.052
b1	1.90	2.41	0.075	0.095
b2	1.90	2.16	0.075	0.085
b3	2.87	3.38	0.113	0.133
b4	2.87	3.13	0.113	0.123
c	0.55	0.68	0.022	0.027
D	20.80	21.10	0.819	0.831
D1	16.25	17.65	0.640	0.695